

# DATA SHEET

## **BLW98** UHF linear power transistor

Product specification

August 1986

# UHF linear power transistor

# BLW98

### DESCRIPTION

N-P-N silicon planar epitaxial transistor primarily intended for use in linear u.h.f. amplifiers of TV transposers and transmitters in band IV-V, as well as for driver stages in tube systems.

### FEATURES:

- diffused emitter ballasting resistors for an optimum temperature profile;
- gold sandwich metallization ensures excellent reliability.

The transistor has a 1/4" capstan envelope with ceramic cap. All leads are isolated from the stud.

### QUICK REFERENCE DATA

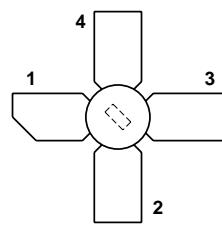
R.F. performance in linear amplifier

MODE OF OPERATION	$f_{\text{vision}}$ MHz	$V_{\text{CE}}$ V	$I_{\text{c}}$ mA	$T_{\text{h}}$ °C	$d_{\text{im}}^{(1)}$ dB	$P_{\text{o sync}}^{(1)}$ W	$G_{\text{p}}$ dB
class-A	860	25	850	70	-60	> 3,5	> 6,5
class-A	860	25	850	25	-60	typ. 4,4	typ. 7,0

### Note

1. Three-tone test method (vision carrier -8 dB, sound carrier -7 dB, sideband signal -16 dB), zero dB corresponds to peak sync level.

### PIN CONFIGURATION



Top view MBK187

Fig.1 Simplified outline. SOT122A.

### PINNING - SOT122A.

PIN	DESCRIPTION
1	collector
2	emitter
3	base
4	emitter

**PRODUCT SAFETY** This device incorporates beryllium oxide, the dust of which is toxic. The device is entirely safe provided that the BeO disc is not damaged.

# UHF linear power transistor

BLW98

## RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Collector-emitter voltage

(peak value);  $V_{BE} = 0$

$V_{CESM}$  max. 50 V

open base

$V_{CEO}$  max. 27 V

Emitter-base voltage (open collector)

$V_{EBO}$  max. 3,5 V

Collector current

d.c.

$I_C$  max. 2 A

(peak value);  $f > 1$  MHz

$I_{CM}$  max. 4 A

Total power dissipation at  $T_h = 70$  °C

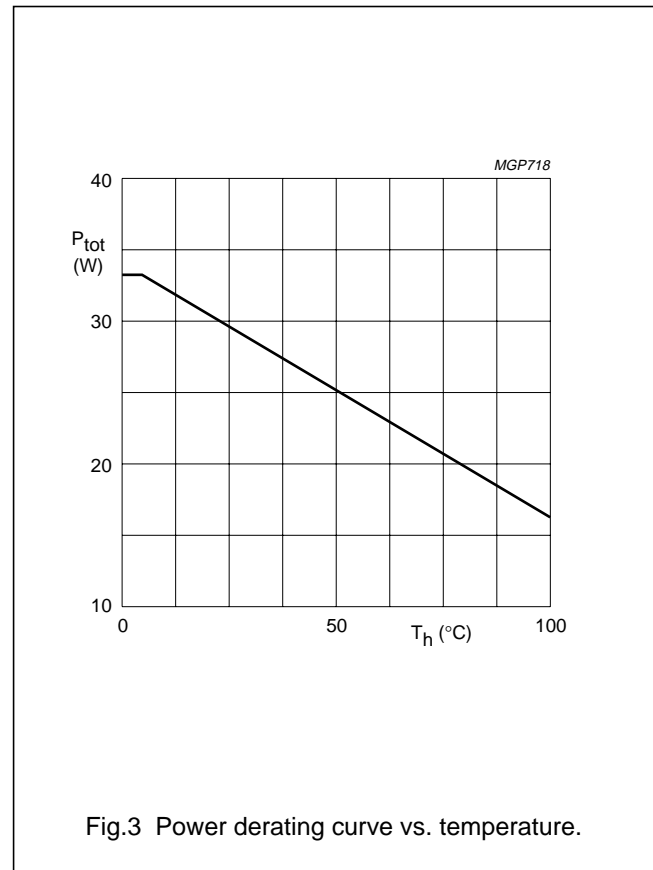
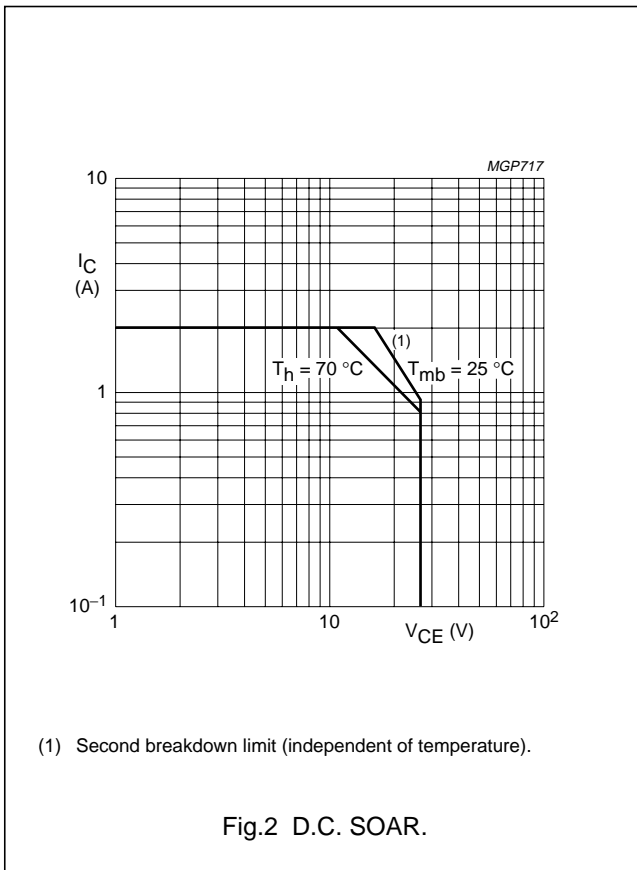
$P_{tot}$  max. 21,5 W

Storage temperature

$T_{stg}$  -65 to +150 °C

Operating junction temperature

$T_j$  max. 200 °C



## THERMAL RESISTANCE

(dissipation = 21,25 W;  $T_{mb} = 82,75$  °C,  $T_h = 70$  °C)

From junction to mounting base

$R_{th\ j-mb}$  = 5,45 K/W

From mounting base to heatsink

$R_{th\ mb-h}$  = 0,6 K/W

UHF linear power transistor

BLW98

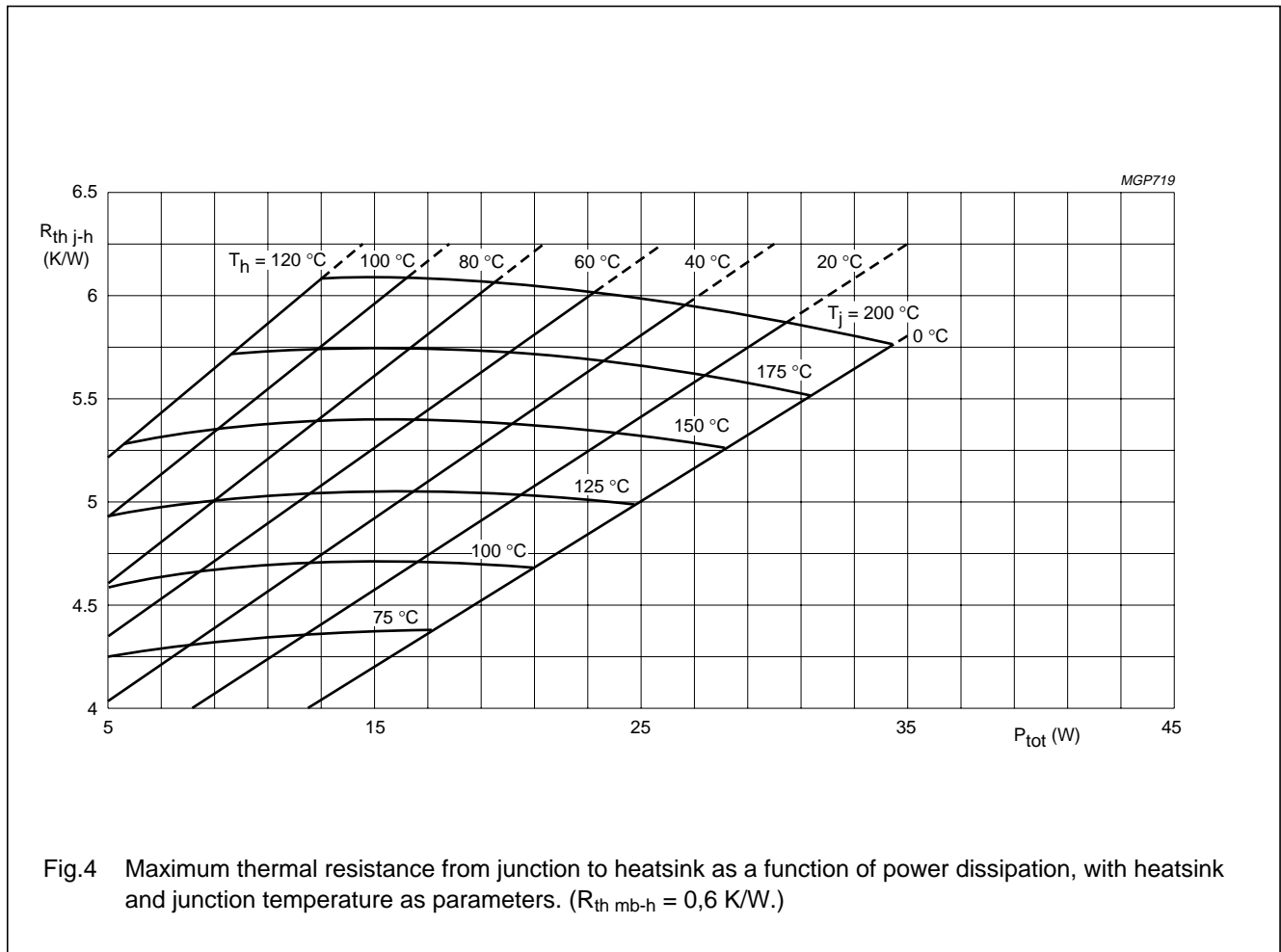


Fig.4 Maximum thermal resistance from junction to heatsink as a function of power dissipation, with heatsink and junction temperature as parameters. ( $R_{th\ mb-h} = 0,6\ K/W$ .)

**Example**

Nominal class-A operation (without r.f. signal):  $V_{CE} = 25\ V$ ;  $I_C = 850\ mA$ ;  $T_h = 70\ ^\circ C$ .

Fig.4 shows:	$R_{th\ j-h}$	max.	6,05	K/W
	$T_j$	max.	200	°C
Typical device:	$R_{th\ j-h}$	typ.	5,35	K/W
	$T_j$	typ.	183	°C

UHF linear power transistor

BLW98

**CHARACTERISTICS**

$T_j = 25\text{ }^\circ\text{C}$  unless otherwise specified

Collector-emitter breakdown voltage

$V_{BE} = 0; I_C = 10\text{ mA}$

open base,  $I_C = 25\text{ mA}$

$V_{(BR)CES} > 50\text{ V}$

$V_{(BR)CEO} > 27\text{ V}$

Emitter-base breakdown voltage

open collector,  $I_E = 5\text{ mA}$

$V_{(BR)EBO} > 3,5\text{ V}$

D.C. current gain<sup>(1)</sup>

$I_C = 850\text{ mA}; V_{CE} = 25\text{ V}$

$h_{FE} > 15$   
typ. 40

Collector-emitter saturation voltage<sup>(1)</sup>

$I_C = 500\text{ mA}; I_B = 100\text{ mA}$

$V_{CEsat}$  typ. 0,25 V

Transition frequency at  $f = 500\text{ MHz}$ <sup>(2)</sup>

$-I_E = 850\text{ mA}; V_{CB} = 25\text{ V}$

$f_T$  typ. 2,5 GHz

Collector capacitance at  $f = 1\text{ MHz}$

$I_E = I_e = 0; V_{CB} = 25\text{ V}$

$C_c$  typ. 24 pF  
< 30 pF

Feedback capacitance at  $f = 1\text{ MHz}$

$I_C = 50\text{ mA}; V_{CE} = 25\text{ V}$

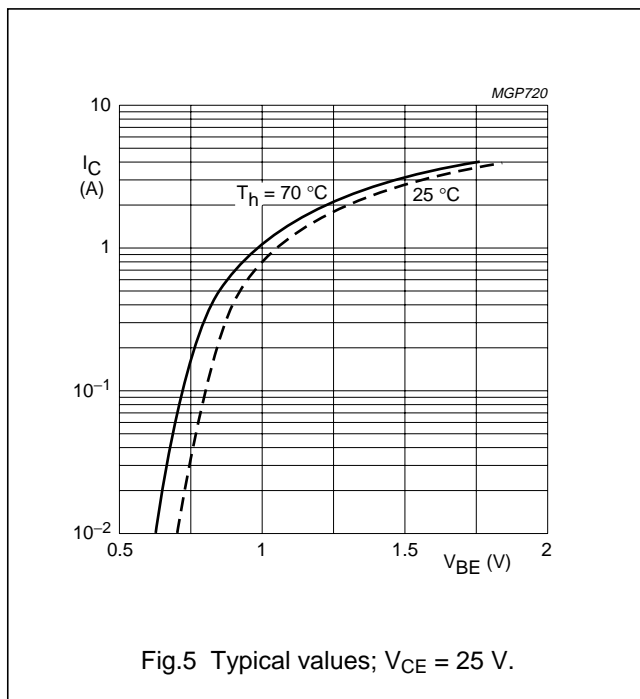
$C_{re}$  typ. 15 pF

Collector-stud capacitance

$C_{CS}$  typ. 1,2 pF

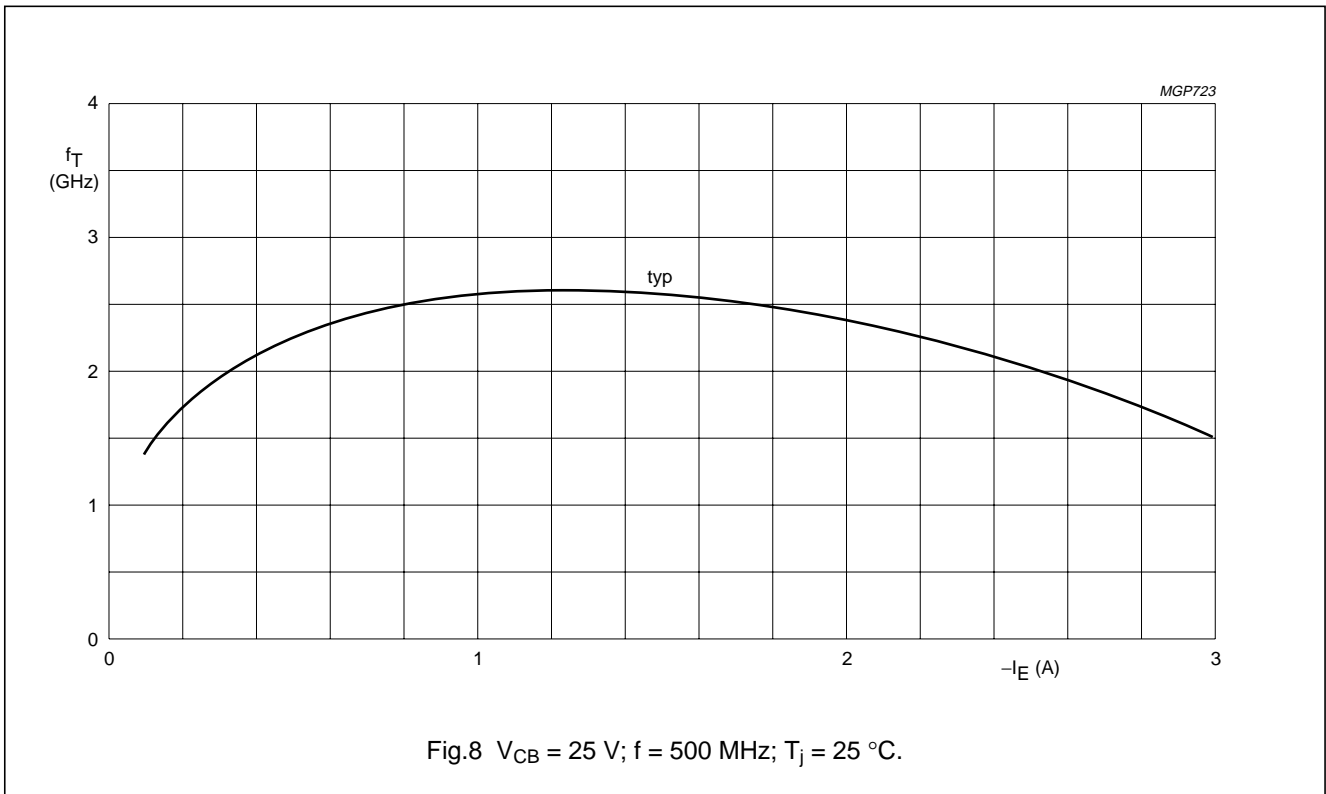
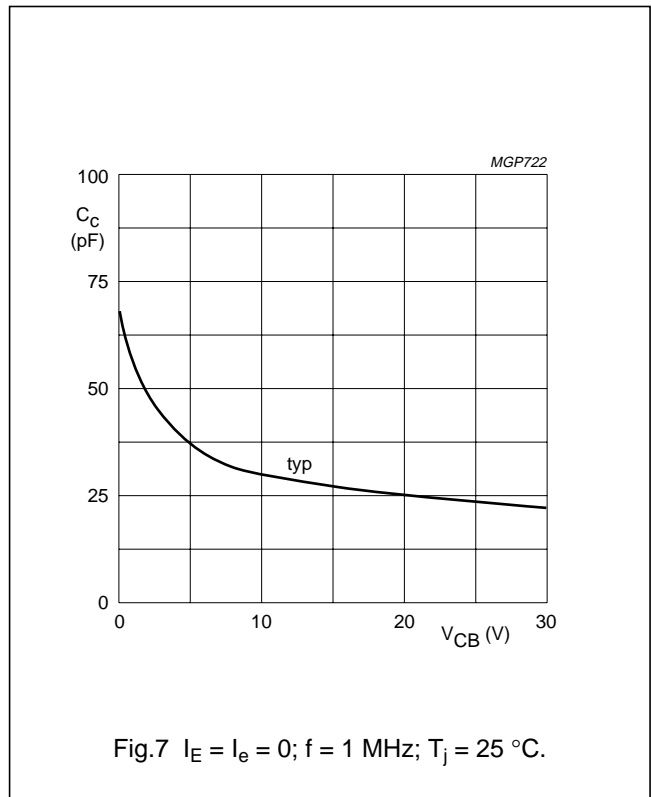
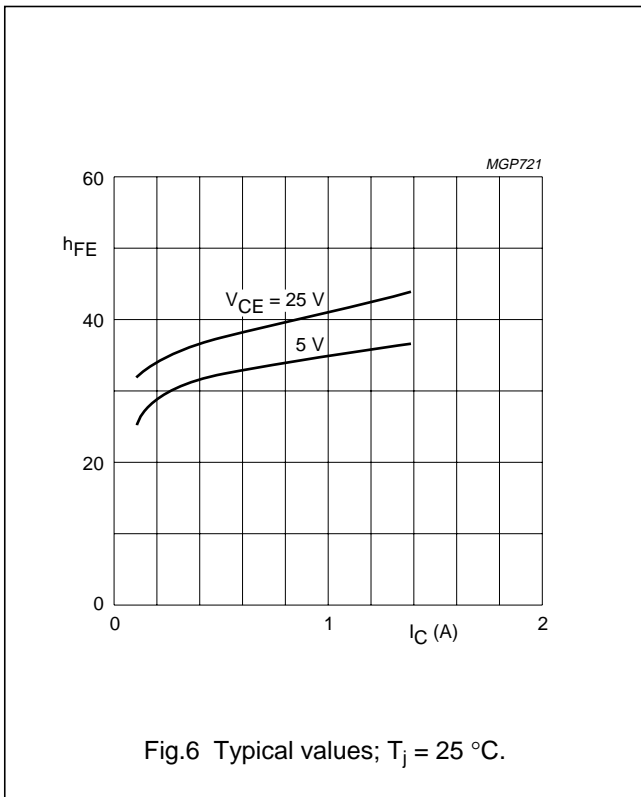
**Notes**

1. Measured under pulse conditions:  $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0,02$ .
2. Measured under pulse conditions:  $t_p \leq 50\text{ }\mu\text{s}; \delta \leq 0,01$ .



UHF linear power transistor

BLW98



UHF linear power transistor

BLW98

APPLICATION INFORMATION

R.F. performance in u.h.f. class-A operation (linear power amplifier)

$f_{\text{vision}}$ (MHz)	$V_{\text{CE}}$ (V)	$I_{\text{C}}$ (mA)	$T_{\text{h}}$ (°C)	$d_{\text{im}}$ (dB) <sup>(1)</sup>	$P_{\text{o sync}}$ (W) <sup>(1)</sup>	$G_{\text{P}}$ (dB)
860	25	850	70	-60	> 3,5	> 6,5
860	25	850	70	-60	typ. 3,8	typ. 7,0
860	25	850	25	-60	typ. 4,4	typ. 7,0

Note

1. Three-tone test method (vision carrier -8 dB, sound carrier -7 dB, sideband signal -16 dB), zero dB corresponds to peak sync level.

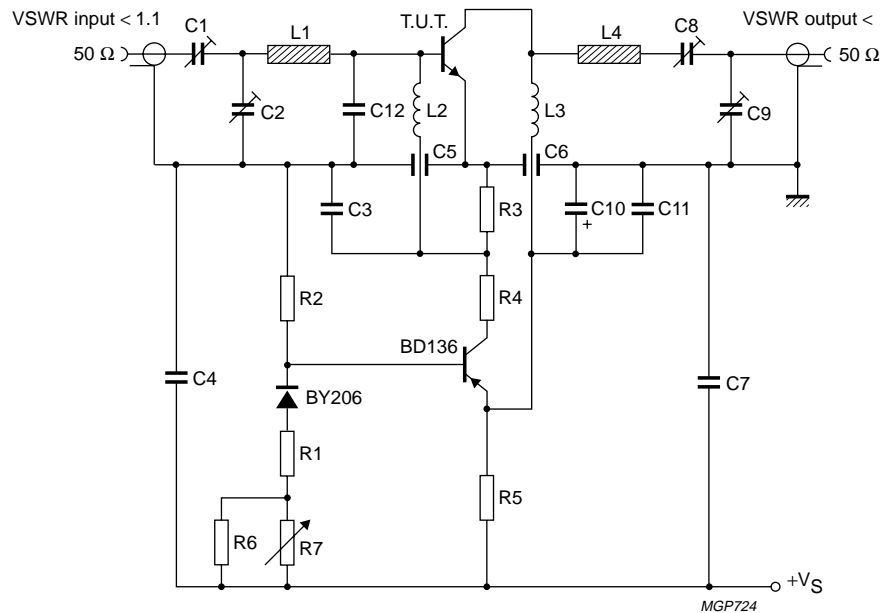


Fig.9 Class-A test circuit at  $f_{\text{vision}} = 860$  MHz.

---

**UHF linear power transistor****BLW98**

---

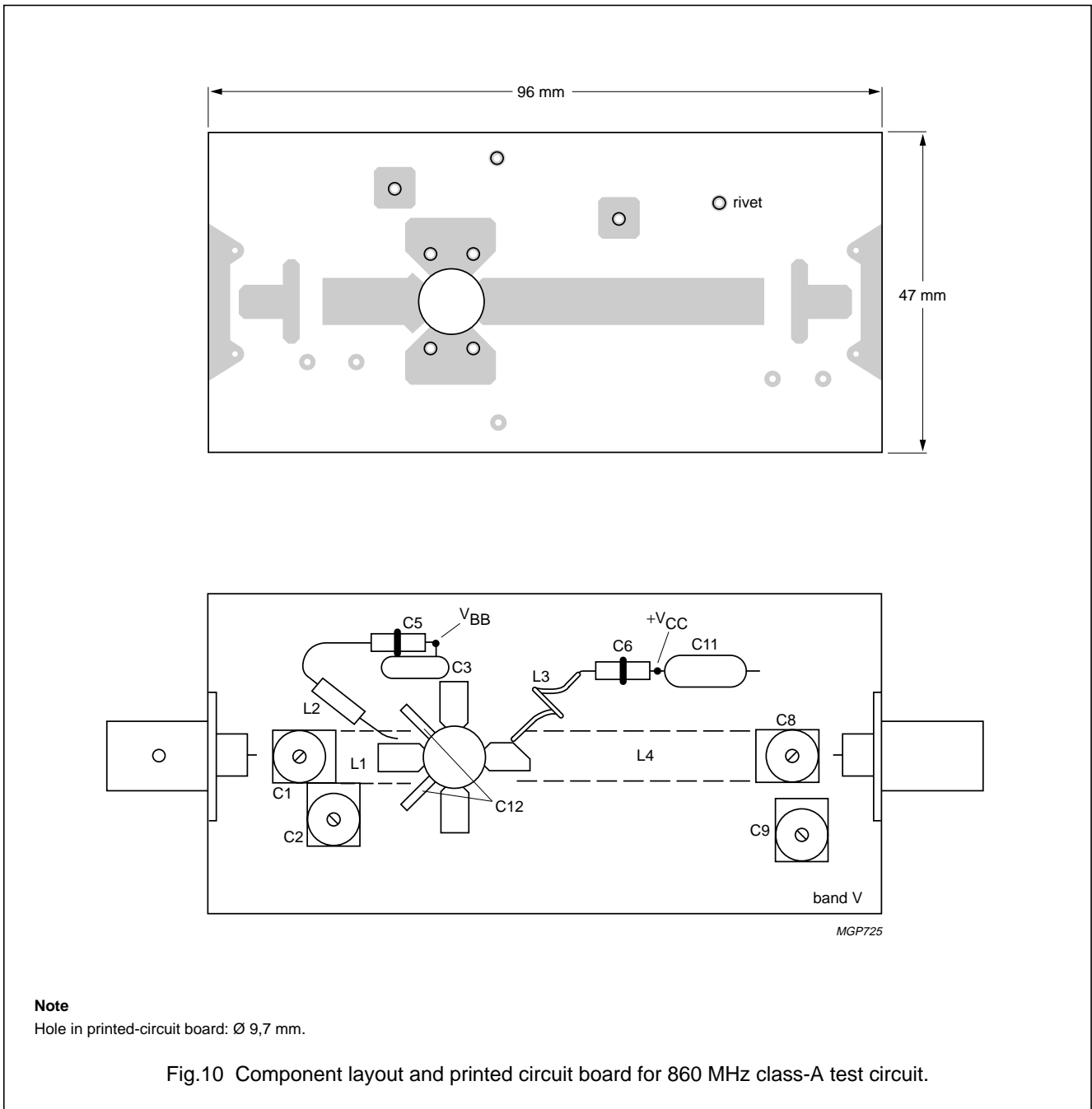
## List of components:

- C1 = C2 = 1,4 to 5,5 pF film dielectric trimmer (cat. no. 2222 809 09001)  
C3 = C4 = 100 nF polyester capacitor  
C5 = C6 = 1 nF feed-through capacitor  
C7 = 5,6 pF ceramic capacitor  
C8 = 2 to 18 pF film dielectric trimmer (cat. no. 2222 809 09003)  
C9 = 2 to 9 pF film dielectric trimmer (cat. no. 2222 809 09002)  
C10 = 10  $\mu$ F/40 V solid aluminium electrolytic capacitor  
C11 = 470 nF polyester capacitor  
C12 = 2  $\times$  3,3 pF chip capacitors (in parallel)  
R1 = 150  $\Omega$  carbon resistor (0,25 W)                      R5 = 4  $\times$  12  $\Omega$  carbon resistors in parallel (1 W each)  
R2 = 1,8 k $\Omega$  carbon resistor (0,5 W)                      R6 = 1 k $\Omega$  carbon resistor (0,25 W)  
R3 = 33  $\Omega$  carbon resistor (0,5 W)                      R7 = 220  $\Omega$  carbon potentiometer (0,25 W)  
R4 = 220  $\Omega$  carbon resistor (1 W)  
L1 = stripline (13,6 mm  $\times$  6,9 mm)  
L2 = microchoke 0,47  $\mu$ H (cat. no. 4322 057 04770)  
L3 = 1 turn Cu wire (1 mm); internal diameter 5,5 mm; leads 2  $\times$  5 mm  
L4 = stripline (40,8 mm  $\times$  6,9 mm)

L1 and L4 are striplines on a double Cu-clad printed-circuit board with PTFE fibre-glass dielectric ( $\epsilon_r = 2,74$ ); thickness 1,5 mm.

UHF linear power transistor

BLW98



The circuit and the components are on one side of the PTFE fibre-glass board, the other side is unetched copper to serve as a ground-plane. Earth connections are made by hollow rivets. Additionally copper straps are used under the emitters and at the input and output to provide direct contact between the copper on the component side and the ground-plane.

UHF linear power transistor

BLW98

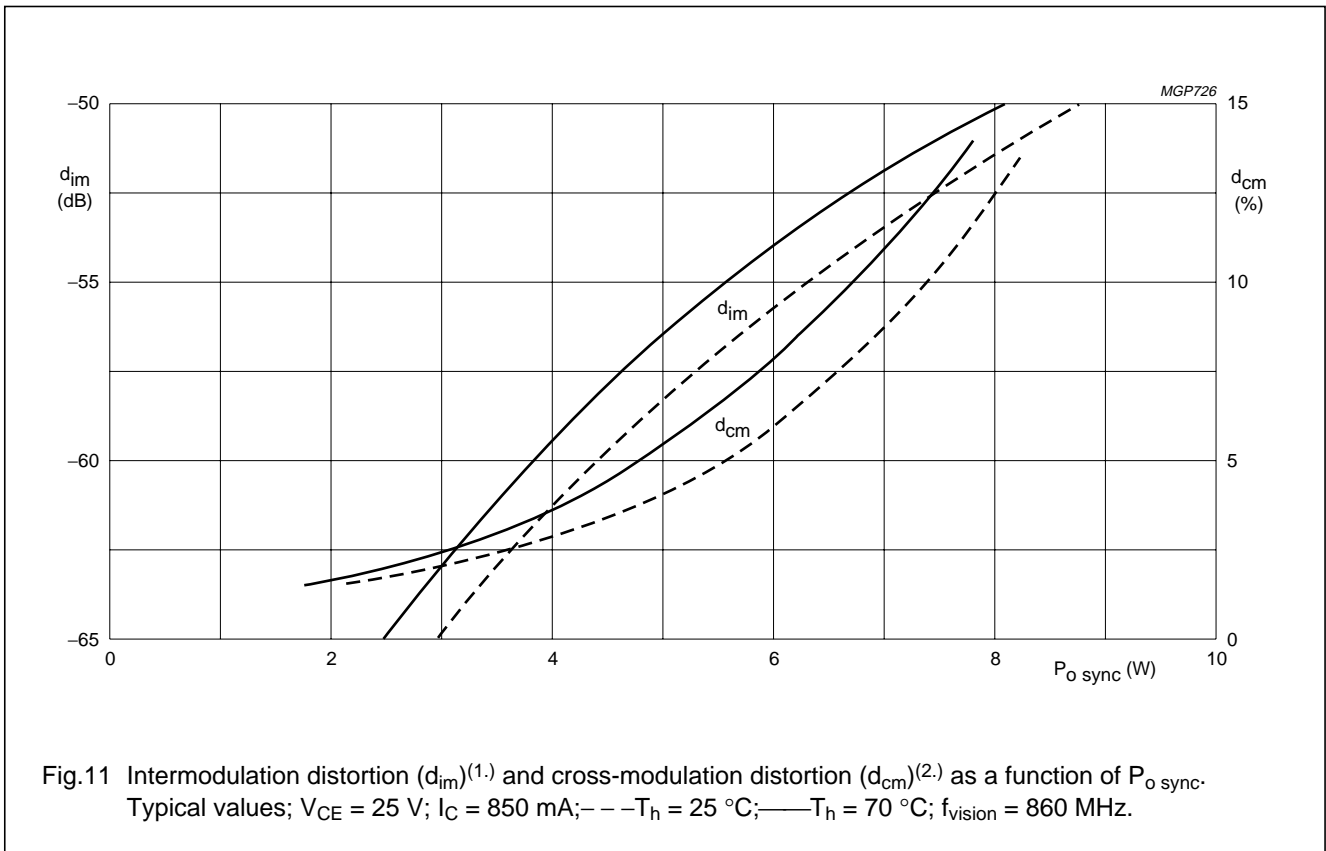
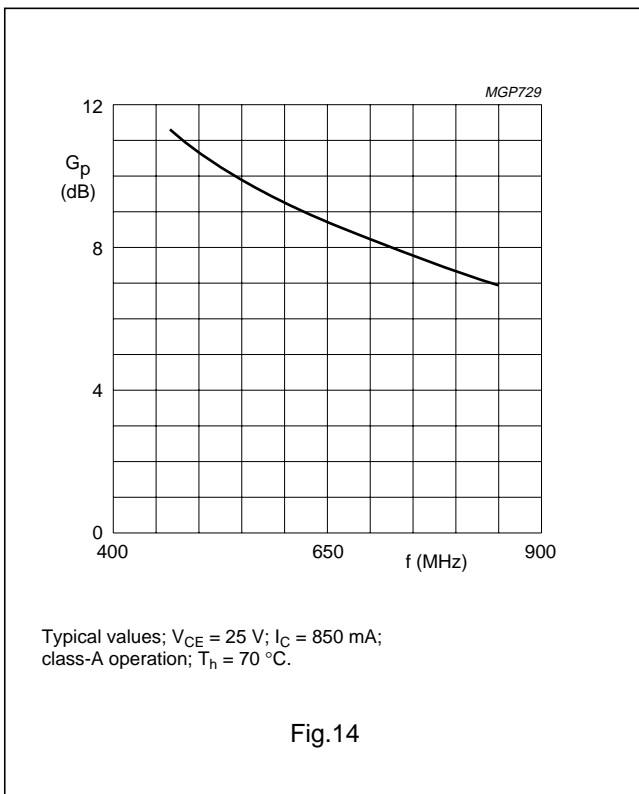
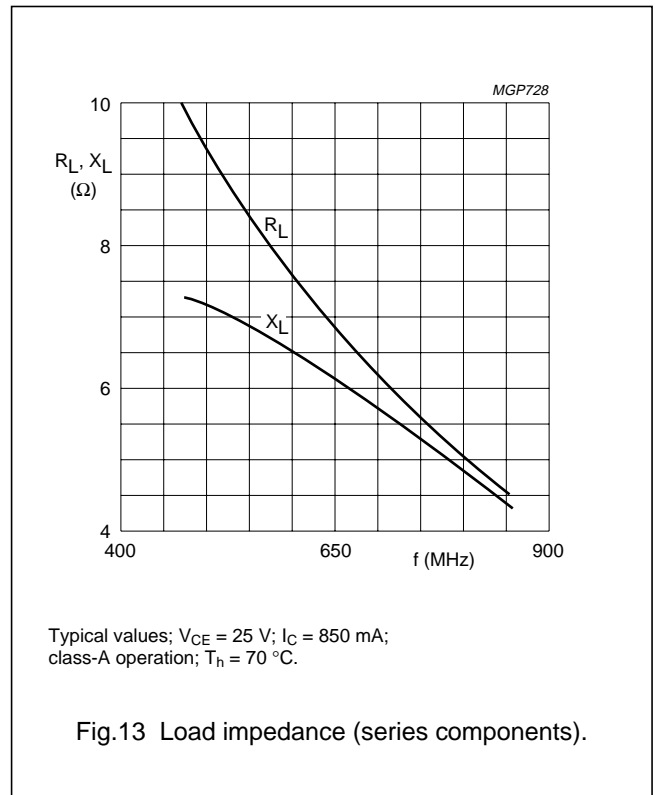
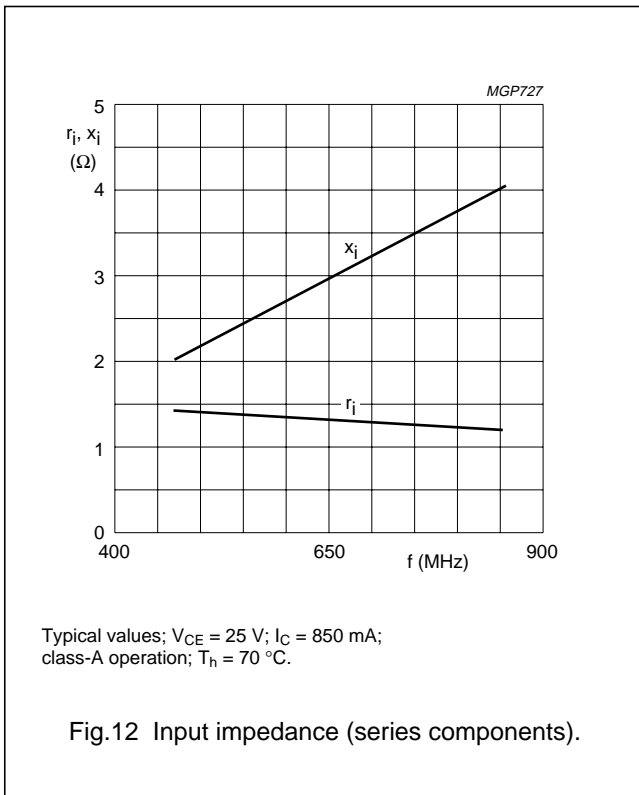


Fig.11 Intermodulation distortion ( $d_{im}$ )<sup>(1.)</sup> and cross-modulation distortion ( $d_{cm}$ )<sup>(2.)</sup> as a function of  $P_{o\ sync}$ . Typical values;  $V_{CE} = 25\text{ V}$ ;  $I_C = 850\text{ mA}$ ; ---  $T_h = 25\text{ }^\circ\text{C}$ ; —  $T_h = 70\text{ }^\circ\text{C}$ ;  $f_{vision} = 860\text{ MHz}$ .

1. Three-tone test method (vision carrier -8 dB, sound carrier -7 dB, sideband signal -16 dB), zero dB corresponds to peak sync level.  
Intermodulation distortion of input signal  $\leq -75\text{ dB}$ .
2. Two-tone test method (vision carrier 0 dB, sound carrier -7 dB), zero dB corresponds to peak sync level.  
Cross-modulation distortion ( $d_{cm}$ ) is the voltage variation (%) of sound carrier when vision carrier is switched from 0 dB to -20 dB.

UHF linear power transistor

BLW98



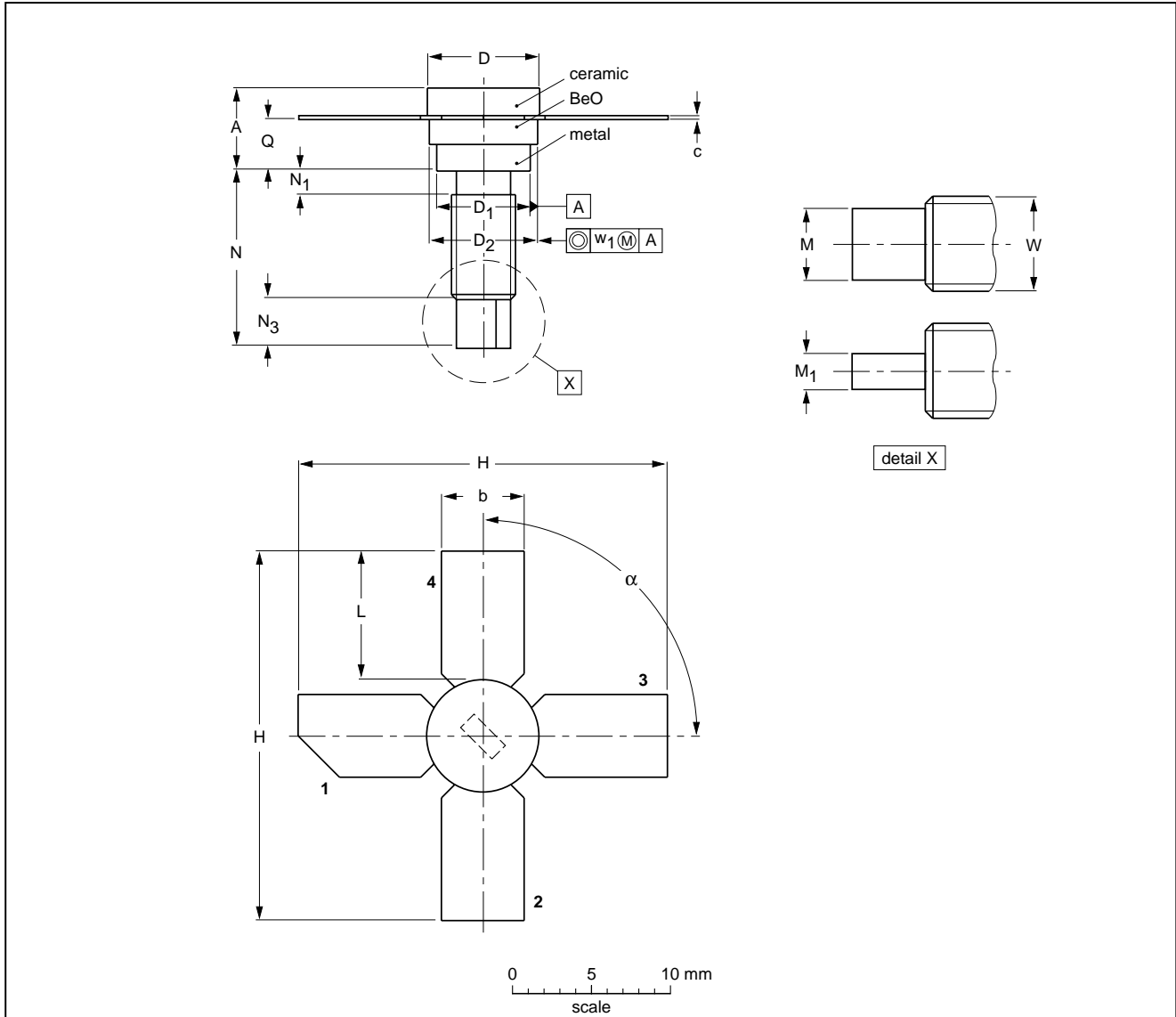
UHF linear power transistor

BLW98

PACKAGE OUTLINE

Studded ceramic package; 4 leads

SOT122A



DIMENSIONS (millimetre dimensions are derived from the original inch dimensions)

UNIT	A	b	c	D	D <sub>1</sub>	D <sub>2</sub>	H	L	M <sub>1</sub>	M	N	N <sub>1</sub> max.	N <sub>3</sub>	Q	W	w <sub>1</sub>	α
mm	5.97 4.74	5.85 5.58	0.18 0.14	7.50 7.23	6.48 6.22	7.24 6.93	27.56 25.78	9.91 9.14	3.18 2.66	1.66 1.39	11.82 11.04	1.02	3.86 2.92	3.38 2.74	8-32 UNC	0.381	90°

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT122A						97-04-18

## UHF linear power transistor

BLW98

**DEFINITIONS**

<b>Data Sheet Status</b>	
Objective specification	This data sheet contains target or goal specifications for product development.
Preliminary specification	This data sheet contains preliminary data; supplementary data may be published later.
Product specification	This data sheet contains final product specifications.
<b>Limiting values</b>	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
<b>Application information</b>	
Where application information is given, it is advisory and does not form part of the specification.	

**LIFE SUPPORT APPLICATIONS**

These products are not designed for use in life support appliances, devices, or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips for any damages resulting from such improper use or sale.



LittleDiode supplies new, hard to find or obsolete electronic components and semiconductors all over the world.

With over two million different components listed you are sure to find the part you need.

Feel free to visit us today at our online store:

[LittleDiode.com](http://LittleDiode.com)

Looking forward to providing you with the best possible service.